

## Descriptions

This is N-CHANNEL 650V 99m $\Omega$  Super-Junction Power MOSFET in a TO-220C Plastic Package

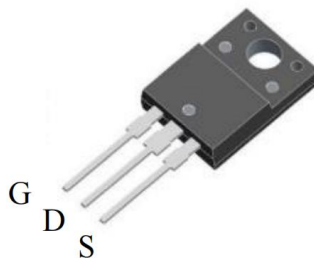
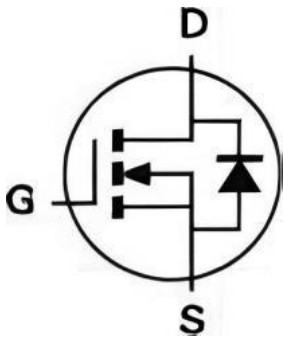
## Features

- Optimized for synchronous rectification
- Low Input Capacitance
- Low Miller Capacitance
- Fully Characterized Capacitance and Avalanche
- Pb-free lead plating; RoHS compliant

## Applications

- BLDC Motor drive applications
- Battery powered circuits
- Synchronous rectifier applications
- Resonant mode power supplies

## Equivalent Circuit & Pining



TO-220C

## Marking

See Marking Instructions.

## Absolute Maximum Ratings(Ta=25°C)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		$V_{DS}$	650	V
Gate-Source Voltage		$V_{GS}$	$\pm 30$	V
Drain Current-Continuous <sup>Note1</sup>	Tc= 25°C	$I_D$	36	A
	Tc= 125°C		23.6	A
Drain Current-Pulsed <sup>Note2</sup>	Tc= 25°C	$I_{DM}$	108	A
Avalanche Current		$I_{AS}$	8.4	A
Single Pulse Avalanche Energy <sup>Note3</sup>		$E_{AS}$	705.6	mJ
Maximum Power Dissipation	Tc= 25°C	$P_{tot}$	208	W
Storage Temperature Range		$T_{STG}$	-55 to 150	°C
Operating Junction Temperature Range		$T_J$	-55 to 150	°C

## Thermal Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Thermal resistance, Junction-to-Ambient <sup>Note4</sup>	Steady State			62	°C/W
Thermal resistance, Junction-to-Case <sup>Note4</sup>	Steady State			0.6	°C/W

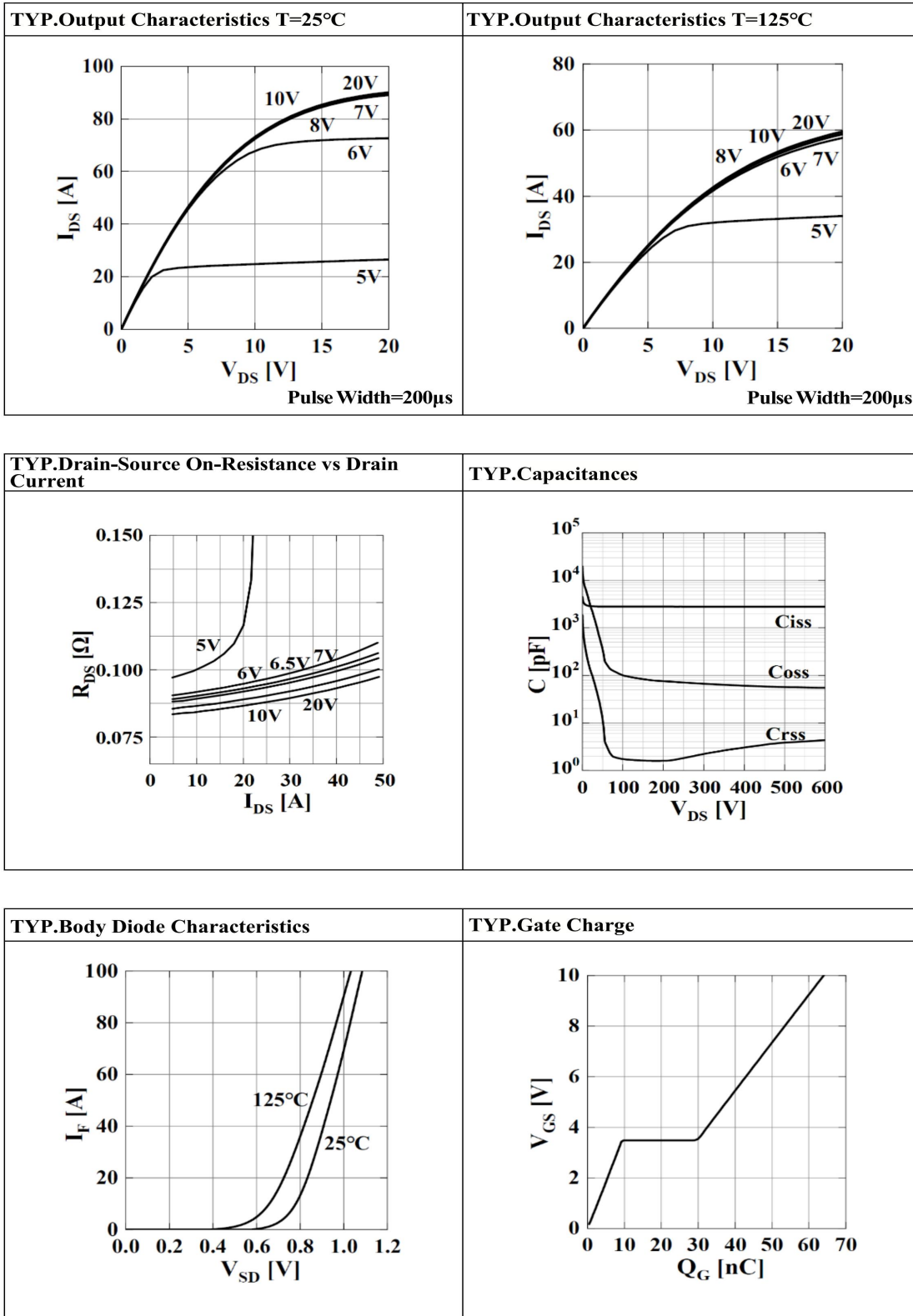
## Electrical Characteristics(Ta=25°C)

STATIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V(BR)DSS	V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA	650			V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	μA
		V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			100	μA
Gate-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
STATIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Gate Threshold Voltage	V <sub>GS</sub> (TH)	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA	2.5		3.5	V
Drain-Source On-State Resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> =10V, I <sub>DS</sub> =17A		91	99	mΩ
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		2.3		Ω
DYNAMIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, f=100kHz		2766		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, f=100kHz		100.2		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, f=100kHz		1.5		pF
Turn-On Delay Time	T <sub>d</sub> (on)	V <sub>DS</sub> =400V, V <sub>GS</sub> =18V, I <sub>DS</sub> =17A, R <sub>G</sub> =3Ω		23.3		ns
Rise Time	t <sub>r</sub>	V <sub>DS</sub> =400V, V <sub>GS</sub> =18V, I <sub>DS</sub> =17A, R <sub>G</sub> =3Ω		56.9		ns
Turn-Off Delay Time	T <sub>d</sub> (off)	V <sub>DS</sub> =400V, V <sub>GS</sub> =18V, I <sub>DS</sub> =17A, R <sub>G</sub> =3Ω		74.2		ns
Fall Time	t <sub>f</sub>	V <sub>DS</sub> =400V, V <sub>GS</sub> =18V, I <sub>DS</sub> =17A, R <sub>G</sub> =3Ω		16.6		ns
GATE CHARGE CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Gate to Source Gate Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 0 to 10V, V <sub>DD</sub> =400V, I <sub>D</sub> =17A		9.8		nC
Gate to Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> = 0 to 10V, V <sub>DD</sub> =400V, I <sub>D</sub> =17A		20.3		nC
Gate Charge Total	Q <sub>G</sub>	V <sub>GS</sub> = 0 to 10V, V <sub>DD</sub> =400V, I <sub>D</sub> =17A		64.1		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>F</sub> =17A		0.82	1.08	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	V <sub>DD</sub> =480V, I <sub>F</sub> =17A, di/dt=100A/μs		341.4	-	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	V <sub>DD</sub> =480V, I <sub>F</sub> =17A, di/dt=100A/μs		5.8	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	V <sub>DD</sub> =480V, I <sub>F</sub> =17A, di/dt=100A/μs		33.8		A

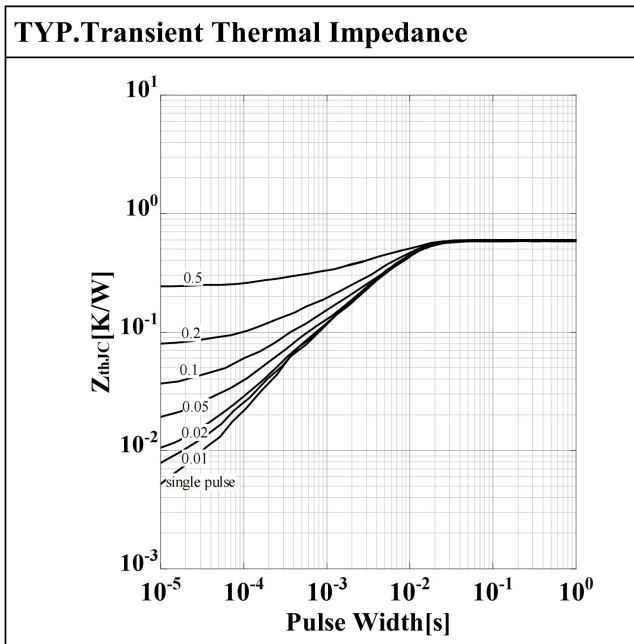
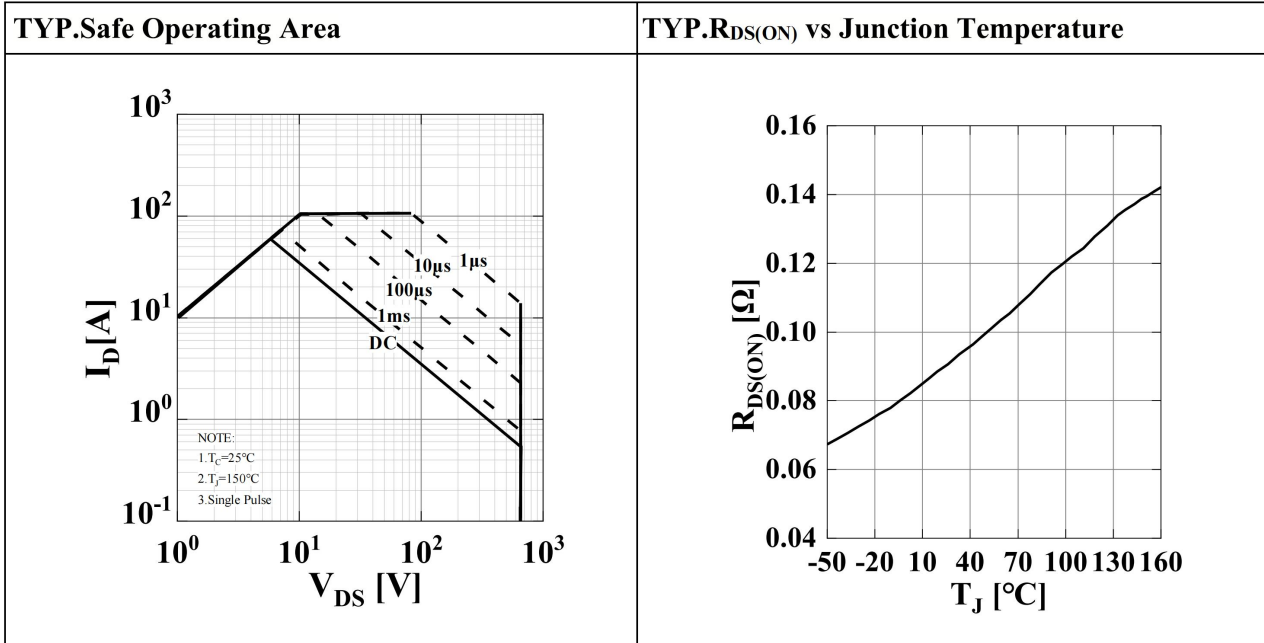
## Notes:

- The maximum current rating is package limited.
- Pulse Test: PulseWidth ≤ 10μs.
- Starting T<sub>J</sub>=25°C, L=20mH, V<sub>D</sub>=50V, V<sub>GS</sub>=10V.
- For surface-mounted devices, both R<sub>th</sub>JC and R<sub>th</sub>JA are measured with the device mounted on approximately 1"×1"FR-4 PCBs. In actual applications, many factors including the PCB material and layout, may affect the thermal resistance of the device-board assembly. For best results, characterize the thermal resistance directly in the application circuit.

Typical Operating Characteristics



Typical Operating Characteristics



## Marking codes



Note:

COT: Company Code

65R099: Product Type.

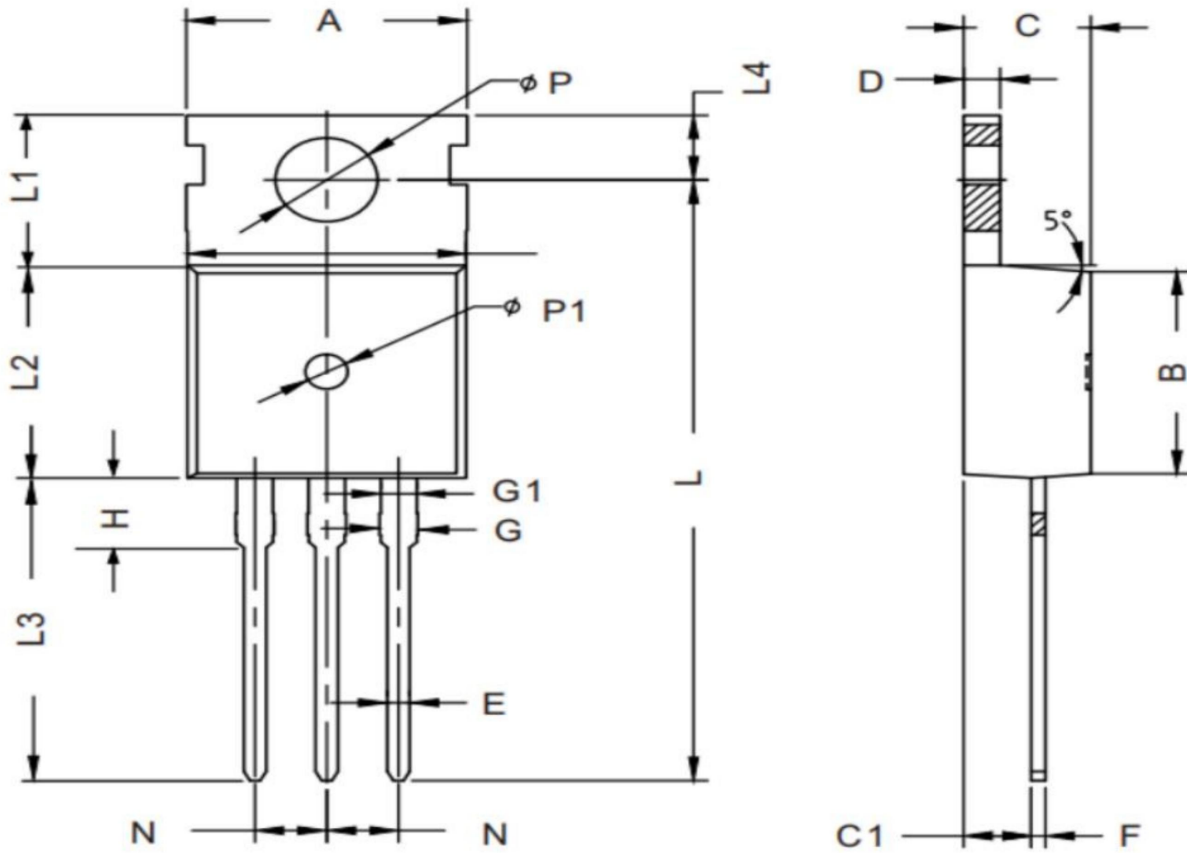
\*\*\*\*\*: \*: Inner Code \* : Year Code \*\*: Week Code \*\*: Lot Code.

## Ordering Information

Ordering Code	RoHS Status	Package	Package Code	Packing
CT65R099CD	Halogen-Free	TO-220C	CD	Tube

Mechanical Dimensions

TO-220C



Symbol	Millimeters		Symbol	Millimeters	
	Min.	Max.		Min.	Max.
A	9.60	10.3	H	2.70	3.30
B	8.40	9.00	L	25.90	26.50
C1	2.20	2.60	L1	6.30	6.70
C	4.30	4.70	L2	9.00	9.40
D	1.20	1.40	L3	12.50	14.10
E	0.70	0.90	L4	2.70	2.90
F	0.40	0.60	N	2.50	2.58
G	1.20	1.50	$\phi P$	3.50	3.70
G1	1.10	1.40	$\phi P1$	1.40	1.60